

# **ZXTC2045E6TA Datasheet**

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DiGi Electronics Part Number	ZXTC2045E6TA-DG
Manufacturer	Diodes Incorporated
Manufacturer Product Number	ZXTC2045E6TA
Description	TRANS NPN/PNP 30V 1.5A SOT23-6
Detailed Description	Bipolar (BJT) Transistor Array 1 NPN, 1 PNP 30V 1.5A 1 1W Surface Mount SOT-26

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# Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
ZXTC2045E6TA	Diodes Incorporated
Series:	Product Status:
	Active
Transistor Type:	Current - Collector (Ic) (Max):
1 NPN, 1 PNP	1.5A
Voltage - Collector Emitter Breakdown (Max):	Vce Saturation (Max) @ lb, lc:
30V	375mV @ 15mA, 750mA
Current - Collector Cutoff (Max):	DC Current Gain (hFE) (Min) @ lc, Vce:
20nA	180 @ 100mA, 2V
Power - Max:	Frequency - Transition:
1.1W	
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Package / Case:	Supplier Device Package:
SOT-23-6	SOT-26
Base Product Number:	
ZXTC2045	

# **Environmental & Export classification**

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.29.0075	





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ZXTC2045E6

#### 30V COMPLEMENTARY MEDIUM POWER TRANSISTOR IN SOT26

#### Features

- NPN + PNP Combination
- BV<sub>CEO</sub> > 30 (-30)V
- BV<sub>CEV</sub> > 40 (-40)V
- I<sub>CM</sub> = 5 (-5)A Peak Pulse Current
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

#### Description

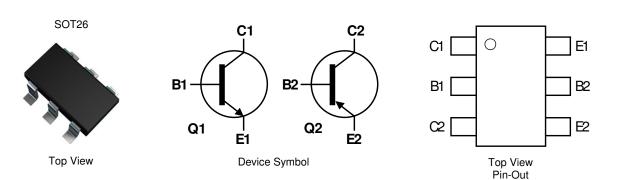
Advanced process capability is used to achieve this high performance device. Combining NPN and PNP transistors, the SOT26 package provides a compact solution for the intended applications.

#### **Mechanical Data**

- Case: SOT26
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads; Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.015 grams (Approximate)

#### **Applications**

- MOSFET and IGBT Gate Driving
- Motor Drive



#### Ordering Information (Notes 4 & 5)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTC2045E6TA	AEC-Q101	2045	7	8	3,000
ZXTC2045E6QTA	Automotive	2045	7	8	3,000

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/ for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free. 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and

<1000ppm antimony compounds.

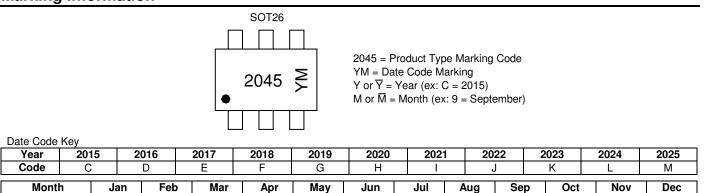
4. Automotive products are AEC-Q101 qualified and PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified.

5. For packaging details, go to our website at http://www.diodes.com

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#### **Marking Information**



Code

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#### Absolute Maximum Ratings – Q1 (NPN Transistor) (@TA = +25 °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	40	V
Collector-Emitter Voltage	V <sub>CEV</sub>	40	V
Collector-Emitter Voltage	V <sub>CEO</sub>	30	V
Emitter-Base Voltage	V <sub>EBO</sub>	7	V
Continuous Collector Current	Ι <sub>C</sub>	1.5	А
Peak Pulsed Collector Current	I <sub>CM</sub>	5	A
Base Current	Ι <sub>Β</sub>	1	A

#### Absolute Maximum Ratings – Q2 (PNP Transistor) (@T<sub>A = +25</sub> °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-40	V
Collector-Emitter Voltage	V <sub>CEV</sub>	-40	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-30	V
Emitter-Base Voltage	V <sub>EBO</sub>	-7	V
Continuous Collector Current	lc	-1.5	A
Peak Pulsed Collector Current	I <sub>CM</sub>	-5	A
Base Current	IB	-1	A

#### Thermal Characteristics (@T<sub>A</sub> = +25 °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit		
Power Dissipation Linear Derating Factor	(Notes 6 & 10)		0.7 5.6			
	(Notes 7 & 10)	PD	0.9 7.2	W mW/℃		
	(Notes 7 & 11)		1.1 8.8			
	(Notes 8 & 10)		1.1 8.8			
	(Notes 9 & 10)		1.7 13.6			
	(Notes 6 & 10)		179			
	(Notes 7 & 10)		139			
Thermal Resistance, Junction to Ambient	(Notes 7 & 11)	$R_{\theta JA}$	113			
	(Notes 8 & 10)		113	°C/W		
	(Notes 9 & 10)		73			
Thermal Resistance, Junction to Lead	(Note 12)	R <sub>θJL</sub>	95.50			
Operating and Storage Temperature Range		TJ, T <sub>STG</sub>	-55 to +150	°C		

#### ESD Ratings (Note 13)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	ЗA
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes: 6. For a device surface mounted on 15mm x 15mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

7. Same as Note 6, except the device is surface mounted on 25mm x 25mm 1oz copper.

8. Same as Note 6, except the device is surface mounted on 50mm x 50mm 2oz copper.

9. Same as Note 8, except the device is measured at t < 5 seconds.

10. For device with one active die, both collectors attached to a common heatsink.

11. For device with two active die running at equal power, split heatsink 50% to each collector.

12. Thermal resistance from junction to solder-point (at the end of the collector lead).

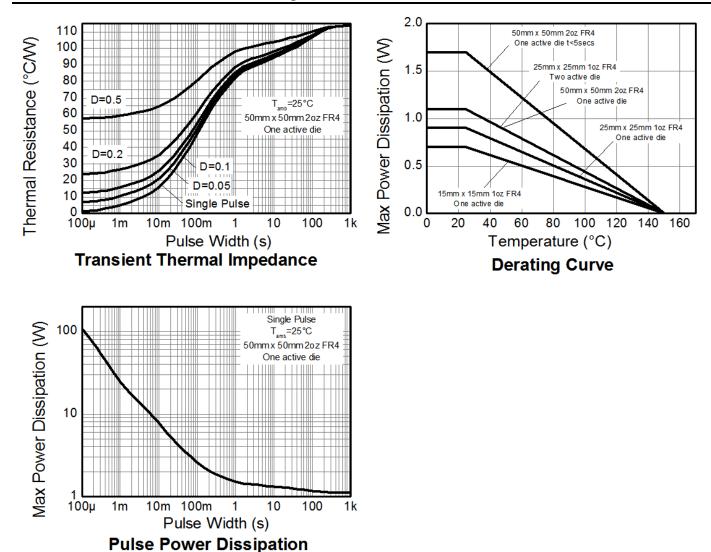
13. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



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### **Thermal Characteristics and Derating Information**







Electrical Characteristics – Q1 (NPN Transistor) (@T <sub>A</sub> = +25 °C, unless otherwise specified.)						
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						·
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	40	-	_	V	$I_{\rm C} = 100 \mu A, I_{\rm E} = 0$
Collector-Emitter Breakdown Voltage	BV <sub>CEV</sub>	40	-		V	$I_{C} = 1\mu A, 0.25V > V_{BE} > 1.0V$
Collector-Emitter Breakdown Voltage (Note 14)	BV <sub>CEO</sub>	30	-		V	$I_{\rm C} = 10 {\rm mA}, I_{\rm B} = 0$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	7	8.3		V	$I_E = 100 \mu A, I_C = 0$
Collector Cut-Off Current	I <sub>CBO</sub>	_	<1	20	nA	$V_{CB} = 32V$
Collector Cut-Off Current	I <sub>CES/R</sub>		<1	20	nA	V <sub>CE</sub> = 16V, R ≤ 1kΩ
Emitter Cut-Off Current	I <sub>EBO</sub>	_	<1	20	nA	V <sub>EB</sub> = 6V
ON CHARACTERISTICS (Note 14)						·
DC Current Gain	h <sub>FE</sub>	180	300	500		$I_{C} = 100 mA, V_{CE} = 2V$
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>		—	375	mV	I <sub>C</sub> = 750mA, I <sub>B</sub> = 15mA
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>	_	—	1,200	mV	I <sub>C</sub> = 750mA, I <sub>B</sub> = 15mA
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	C <sub>obo</sub>		9	20	pF	V <sub>CB</sub> = 10V, f = 1.0MHz
Current Gain-Bandwidth Product	fT		265	—	MHz	V <sub>CE</sub> = 10V, I <sub>C</sub> = 50mA, f = 100MHz
Delay Time	t <sub>d</sub>	_	10		ns	
Rise Time	t <sub>r</sub>		12		ns	$V_{CC} = 10V, I_{C} = 1A$
Storage Time	ts		185		ns	$I_{B1} = -I_{B2} = 50 \text{mA}$
Fall Time	t <sub>f</sub>		45		ns	]

## Electrical Characteristics – Q2 (PNP Transistor) (@T<sub>A</sub> = +25 °C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS	• ,		- 76		•	
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	-40	-		V	$I_{\rm C} = -100\mu A, I_{\rm E} = 0$
Collector-Emitter Breakdown Voltage	BVCEV	-40	-		V	$I_{C} = -1\mu A$ , 0.25V < $V_{BE}$ < 1.0V
Collector-Emitter Breakdown Voltage (Note 14)	BV <sub>CEO</sub>	-30	-	_	V	$I_{\rm C} = -10 {\rm mA}, I_{\rm B} = 0$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	-7	-8.3	_	V	$I_{\rm E} = -100 \mu A, I_{\rm C} = 0$
Collector Cut-Off Current	I <sub>CBO</sub>	_	<-1	-20	nA	V <sub>CB</sub> = -32V
Collector Cut-Off Current	I <sub>CES/R</sub>	_	<-1	-20	nA	V <sub>CE</sub> = -16V, R ≤ 1kΩ
Emitter Cut-Off Current	I <sub>EBO</sub>	_	<-1	-20	nA	$V_{EB} = -6V$
ON CHARACTERISTICS (Note 14)						
DC Current Gain	h <sub>FE</sub>	180	300	500		$I_{C} = -100 \text{mA}, V_{CE} = -2 \text{V}$
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>		_	-375	mV	I <sub>C</sub> = -750mA, I <sub>B</sub> = -15mA
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>	_	_	-1,200	mV	I <sub>C</sub> = -750mA, I <sub>B</sub> = -15mA
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	Cobo	_	9	20	pF	V <sub>CB</sub> = -10V, f = 1.0MHz
Current Gain-Bandwidth Product	f <sub>T</sub>		195	_	MHz	V <sub>CE</sub> = -10V, I <sub>C</sub> = -50mA, f = 100MHz
Delay Time	t <sub>d</sub>		16	_	ns	
Rise Time	tr	_	11	_	ns	V <sub>CC</sub> = -10V, I <sub>C</sub> = -1A
Storage Time	ts	_	220		ns	$I_{B1} = -I_{B2} = -50 \text{mA}$
Fall Time	t <sub>f</sub>	_	31	_	ns	

Note: 14. Measured under pulsed conditions. Pulse width  $\leq$  300µs. Duty cycle  $\leq$  2%.

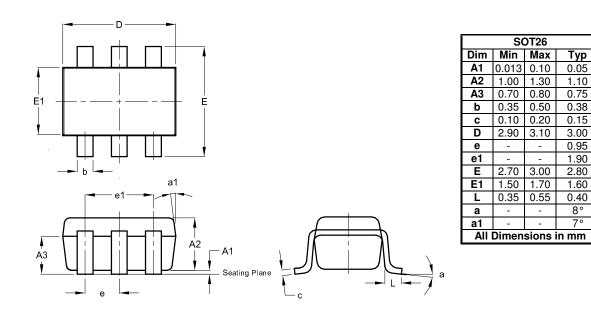




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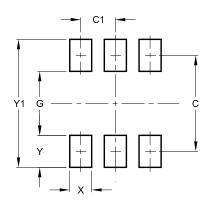
#### **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



#### Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	2.40
C1	0.95
G	1.60
Х	0.55
Y	0.80
Y1	3.20





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